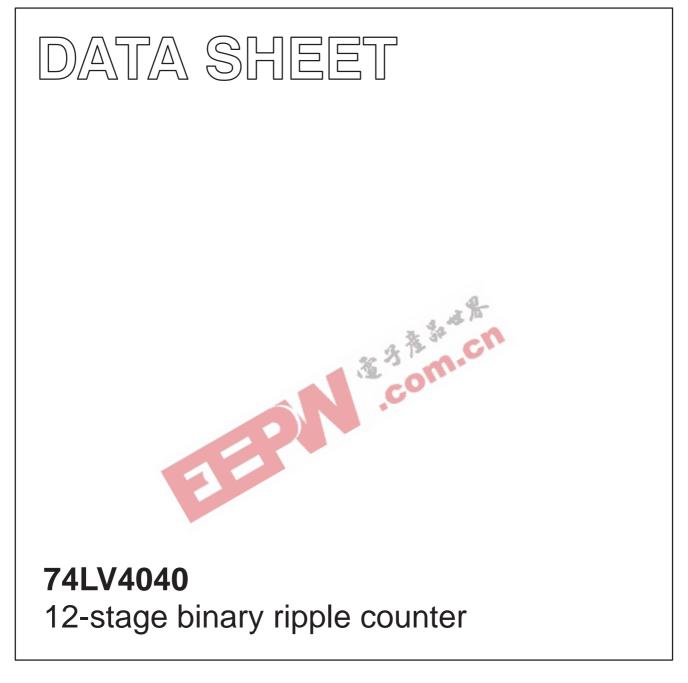
INTEGRATED CIRCUITS



Product specification IC24 Data Handbook 1998 Jun 23



74LV4040

FEATURES

- Optimized for Low Voltage applications: 1.0 to 5.5V
- Accepts TTL input levels between $V_{CC} = 2.7V$ and $V_{CC} = 3.6V$
- Typical V_{OLP} (output ground bounce) $< 0.8V @ V_{CC} = 3.3V$, $T_{amb} = 25^{\circ}C$
- Typical V_{OHV} (output V_{OH} undershoot) > 2V @ V_{CC} = 3.3V, $T_{amb} = 25^{\circ}C$
- Frequency dividing circuits
- Time delay circuits
- Control counters
- Output capability: standard
- I_{CC} category: MSI

QUICK REFERENCE DATA

DESCRIPTION

The 74LV4040 is a low-voltage Si-gate CMOS device and is pin and function compatible with 74HC/HCT4040.

The 74LV4040 is a 12-stage binary ripple counter with a click input (CP), an overriding asynchronous master reset input (MR) and twelve fully buffered parallel outputs (Q0 to Q11). The counter is advanced on the HIGH-to-LOW transition of CP. A HIGH on MR clears all counter stages and forces all outputs LOW, independent of the state of CP.

Each counter stage is a static toggle flip-flop.

S...

SYMBOL	25°C; $t_r = t_f \le 2.5 \text{ ns}$	CONDITIONS	TYPICAL	UNIT
tphl/tplh	$\begin{tabular}{lllllllllllllllllllllllllllllllllll$	C _L = 15pF V _{CC} = 3.3V	12 7 16	ns
f _{max}	Maximum clock frequency		100	MHz
CI	Input capacitance		3.5	pF
C _{PD}	Power dissipation capacitance per gate	Notes 1 and 2	30	pF

NOTES:

NOTES: 1. C_{PD} is used to determine the dynamic power dissipation (P_D in μ W) P_D = C_{PD} × V_{CC}² × f_i + Σ (C_L × V_{CC}² × f₀) where: f_i = input frequency in MHz; C_L = output load capacity in pF; f₀ = output frequency in MHz; V_{CC} = supply voltage in V; Σ (C_L × V_{CC}² × f₀) = sum of the outputs. 2. The condition is V_I = GND to V_{CC}

ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	PKG. DWG. #
16-Pin Plastic DIL	–40°C to +125°C	74LV4040 N	74LV4040 N	SOT38-4
16-Pin Plastic SO	–40°C to +125°C	74LV4040 D	74LV4040 D	SOT109-1
16-Pin Plastic SSOP Type II	–40°C to +125°C	74LV4040 DB	74LV4040 DB	SOT338-1
16-Pin Plastic TSSOP Type I	-40°C to +125°C	74LV4040 PW	74LV4040PW DH	SOT403-1

74LV4040

PIN CONFIGURATION

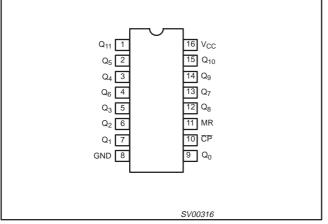
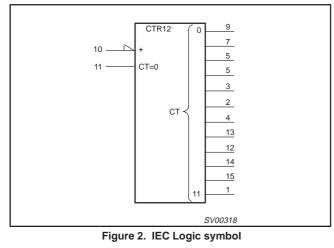


Figure 1. Pin configuration

PIN DESCRIPTION

PIN NUMBER	SYMBOL	FUNCTION
9, 7, 6, 5, 3, 2, 4, 13, 12, 14, 15, 1	Q_0 to Q_{11}	Parallel outputs
8	GND	Ground (0V)
10	CP	Clock input (HIGH-to-LOW, edge- triggered)
11	MR	Master reset input (active HIGH)
16	V _{CC}	Positive supply voltage

LOGIC SYMBOL (IEEE/IEC)



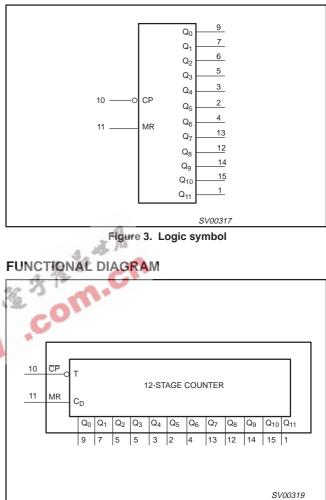


Figure 4. Functional diagram

LOGIC DIAGRAM

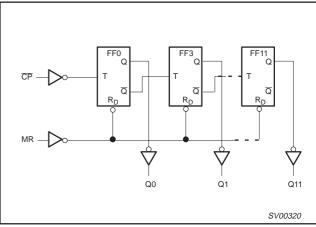


Figure 5. Logic diagram

LOGIC SYMBOL

74LV4040

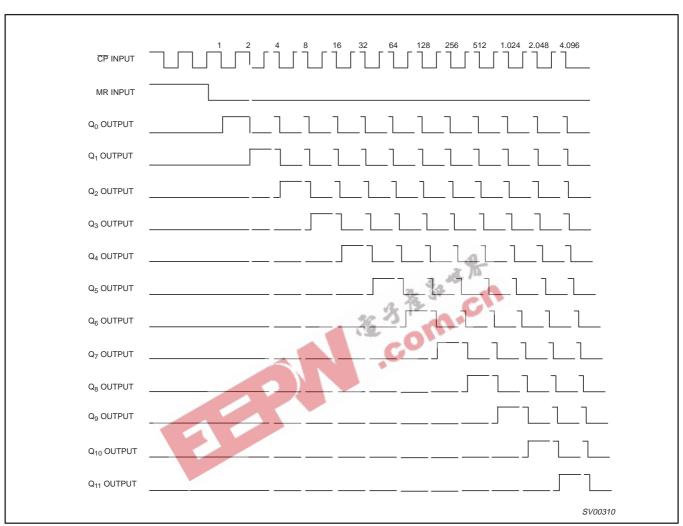


Figure 6. Timing diagram

FUNCTION TABLE

INP	OUTPUTS	
CP	MR	Q ₀ , Q ₃ to Q ₁₃
<u>↑</u>	L	no change
↓ ↓	L	count
Х	Н	L

NOTES: H = HIGH voltage level L = LOW voltage level X = Don't care ↑ = LOW -to-HIGH clock transition ↓ = HIGH-to-LOW clock transition

74LV4040

ABSOLUTE MAXIMUM RATINGS^{1, 2}

In accordance with the Absolute Maximum Rating System (IEC 134)

Voltages are referenced to GND (ground = 0V)

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V _{CC}	DC supply voltage		-0.5 to +7.0	V
±Ι _{ΙΚ}	DC input diode current	$V_{\rm I} < -0.5 \text{ or } V_{\rm I} > V_{\rm CC} + 0.5 \text{V}$	20	mA
±І _{ОК}	DC output diode current	$V_{\rm O}$ < -0.5 or $V_{\rm O}$ > $V_{\rm CC}$ + 0.5V	50	mA
±IO	DC output source or sink current – standard outputs	$-0.5V < V_O < V_{CC} + 0.5V$	25	mA
±I _{GND} , ±I _{CC}	DC V _{CC} or GND current for types with -standard outputs		50	mA
T _{stg}	Storage temperature range		-65 to +150	°C
P _{TOT}	Power dissipation per package –plastic DIL –plastic mini-pack (SO) –plastic shrink mini-pack (SSOP and TSSOP)	for temperature range: -40 to +125°C above +70°C derate linearly with 12mW/K above +70°C derate linearly with 8 mW/K above +60°C derate linearly with 5.5 mW/K	750 500 400	mW

NOTES:
Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

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RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP.	MAX	UNIT
V _{CC}	DC supply voltage	See Note ¹	1.0	3.3	5.5	V
VI	Input voltage		0	-	V _{CC}	V
V _O	Output voltage		0	-	V _{CC}	V
T _{amb}	Operating ambient temperature range in free air	See DC and AC characteristics	-40 -40		+85 +125	°C
t _r , t _f	Input rise and fall times	$V_{CC} = 1.0V \text{ to } 2.0V \\ V_{CC} = 2.0V \text{ to } 2.7V \\ V_{CC} = 2.7V \text{ to } 3.6V \\ V_{CC} = 3.6V \text{ to } 5.5V$	- - - -		500 200 100 50	ns/V

NOTE:

1. The LV is guaranteed to function down to V_{CC} = 1.0V (input levels GND or V_{CC}); DC characteristics are guaranteed from V_{CC} = 1.2V to V_{CC} = 5.5V.

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DC CHARACTERISTICS FOR THE LV FAMILY

Over recommended operating conditions voltages are referenced to GND (ground = 0V)

					LIMITS			
SYMBOL	PARAMETER	TEST CONDITIONS	-40)°C to +8	5°C	-40°C to	o +125°C	Тими Г
			MIN	TYP ¹	MAX	MIN	MAX	1
		$V_{CC} = 1.2V$	0.9			0.9		
V _{IH}	HIGH level Input	$V_{CC} = 2.0V$	1.4			1.4		
٩IH	voltage	V _{CC} = 2.7 to 3.6V	2.0			2.0		ľ
		$V_{CC} = 4.5$ to 5.5V	0.7*V _{CC}			0.7*V _{CC}		
		$V_{CC} = 1.2V$			0.3		0.3	
VIL	LOW level Input	$V_{CC} = 2.0V$			0.6		0.6	
۷IL	voltage	V _{CC} = 2.7 to 3.6V			0.8		0.8	ľ
		V _{CC} = 4.5 to 5.5			0.3*V _{CC}		0.3*V _{CC}	
		$V_{CC} = 1.2V; V_I = V_{IH} \text{ or } V_{IL;} - I_O = 100 \mu A$		1.2				
		$V_{CC} = 2.0V; V_I = V_{IH} \text{ or } V_{IL;} - I_O = 100 \mu A$	1.8	2.0		1.8		1
V _{OH}	HIGH level output voltage; all outputs	$V_{CC} = 2.7V; V_I = V_{IH} \text{ or } V_{IL;} - I_O = 100 \mu A$	2.5	2.7	5	2.5		V
	ronago, an outputo	$V_{CC} = 3.0V; V_I = V_{IH} \text{ or } V_{IL;} - I_O = 100 \mu A$	2.8	3.0		2.8		1
		$V_{CC} = 4.5V; V_I = V_{IH} \text{ or } V_{IL;} - I_O = 100 \mu A$	4.3	4.5	2.20	4.3		1
V _{OH}	HIGH level output voltage;	$V_{CC} = 3.0V$; $V_I = V_{IH}$ or V_{IL} ; $-I_O = 6mA$	2.40	2.82		2.20		
VOH	STANDARD outputs	$V_{CC} = 4.5V$; $V_I = V_{IH}$ or V_{IL} ; $-I_O = 12mA$	3.60	4.20		3.50		
		$V_{CC} = 1.2V; V_1 = V_{IH} \text{ or } V_{IL}; I_0 = 100 \mu A$		0				
	LOW level output	$V_{CC} = 2.0V$; $V_I = V_{IH}$ or V_{IL} ; $I_O = 100\mu A$		0	0.2		0.2	
V _{OL}	voltage; all outputs	V_{CC} = 2.7V; V_I = V_{IH} or V_{IL} ; I_O = 100 μ A		0	0.2		0.2	V
		$V_{CC} = 3.0V; V_I = V_{IH} \text{ or } V_{IL;} I_O = 100 \mu A$		0	0.2		0.2	
		$V_{CC} = 4.5V; V_1 = V_{IH} \text{ or } V_{IL;} I_0 = 100 \mu A$		0	0.2		0.2	
V _{OL}	LOW level output voltage;	$V_{CC} = 3.0V; V_I = V_{IH} \text{ or } V_{IL}; I_O = 6mA$		0.25	0.40		0.50	
VOL	STANDARD outputs	$V_{CC} = 4.5V$; $V_I = V_{IH}$ or V_{IL} ; $I_O = 12mA$		0.35	0.55		0.65	
I	Input leakage current	V_{CC} = 5.5V; V_I = V_{CC} or GND			1.0		1.0	μA
I _{CC}	Quiescent supply current; MSI	$V_{CC} = 5.5V; V_I = V_{CC} \text{ or GND}; I_O = 0$			20.0		160	μA
ΔI_{CC}	Additional quiescent supply current per input	$V_{CC} = 2.7V$ to 3.6V; $V_{I} = V_{CC} - 0.6V$			500		850	μA

NOTE: 1. All typical values are measured at $T_{amb} = 25^{\circ}C$.

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Product specification

AC CHARACTERISTICS

GND = 0V; t_r = t_f \leq 2.5ns; CL = 50pF; RL = 500 Ω

SYMBOL	PARAMETER	WAVEFORM	CONDITION	_	LIMITS 40 to +85 °	С		IITS +125 °C	UNIT	
			V _{CC} (V)	MIN	TYP ¹	MAX	MIN	MAX		
			1.2	-	60	-	-	-		
			2.0	-	27	43	-	54		
t _{PHL} /t _{PLH}	Propagation delay \overline{CP} to Q_0	Figure 7, 9	2.7	-	19	31	-	38	ns	
			3.0 to 3.6	-	16 ²	26	-	32		
			4.5 to 5.5	-	1 ³	17	-	22		
			1.2	-	40	-	-	-		
			2.0	-	18	29	-	54		
t _{PHL} /t _{PLH}	Propagation delay Q _n to Q _{n+1}	Figure 7, 9	2.7	-	13	21	-	38	ns	
			3.0 to 3.6	-	11 ²	18	-	32		
			4.5 to 5.5	-	7 ³	12	-	22		
	Propagation delay ^t PHL MR to Q _n			1.2	-	55	-	-	-	
			2.0	3.1	27	44	-	54		
t _{PHL}		Figure 8, 9	2.7	5-28	19	31	-	38	ns	
			3.0 to 3.6	-	16 ²	26	-	32		
			4.5 to 5.5		11 ³	17	-	22		
		Figure 7	2.0	35	7	-	41	54		
t	Clock pulse width		Figure 7	2.7	25	5	-	30	-	ns
tw	HIGH to LOW		3.0 to 3.6	20	4 ²	-	24	-	115	
			4.5 to 5.5	15	3 ³	-	18	-		
			2.0	35	11	-	41	-		
t	Master reset pulse	Figure 8	2.7	25	9	-	30	-	ns	
t _W	width HIGH	rigule o	3.0 to 3.6	20	8 ²	-	24	-	115	
			4.5 to 5.5	15	7 ³	-	18	-		
			1.2	-	10	-	-	-		
			2.0	22	5	-	26	-		
t _{rem}	t _{rem} Removal time MR to CP	Figure 8	2.7	16	4	-	19	-	ns	
			3.0 to 3.6	13	3 ²	-	15	-		
			4.5 to 5.5	10	2 ³	-	12	-		
			2.0	14	60	-	12	-		
£	Maximum clock	Figure 7	2.7	19	76	-	16	-	MHz	
f _{max}	pulse frequency	Figure 7	3.0 to 3.6	24	94 ²	-	20	-	IVITIZ	
			4.5 to 5.5	36	112 ³	-	30	-		

NOTES:

1. Unless otherwise stated, all typical values are at $T_{amb} = 25^{\circ}C$. 2. Typical value measured at $V_{CC} = 3.3V$. 3. Typical value measured at $V_{CC} = 5.0V$.

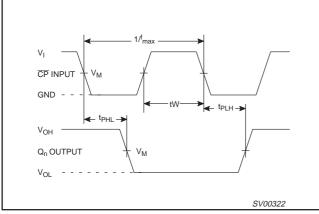
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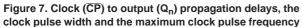
12-stage binary ripple counter

74LV4040

AC WAVEFORMS

 V_M = 1.5V at $V_{CC} \ge 2.7V \le 3.6V$ V_M = 0.5V * V_{CC} at $V_{CC} < 2.7V$ and $\ge 4.5V$ V_{OL} and V_{OH} are the typical output voltage drop that occur with the output load.





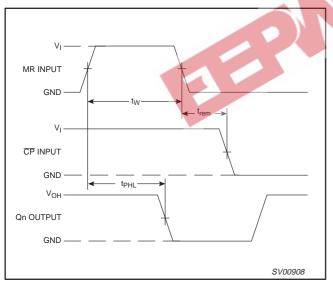
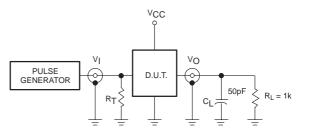


Figure 8. Master reset (MR) pulse width, the master reset to output (Q_n) propagation delays and the master reset to clock (\overline{CP}) removal time

TEST CIRCUIT



Test Circuit for switching times

DEFINITIONS

R_L = Load resistor

 $\ensuremath{\mathsf{C}}_{\ensuremath{\mathsf{L}}}$ = Load capacitance includes jig and probe capacitance

 R_T = Termination resistance should be equal to Z_{OUT} of pulse generators.

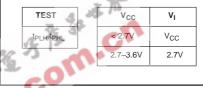
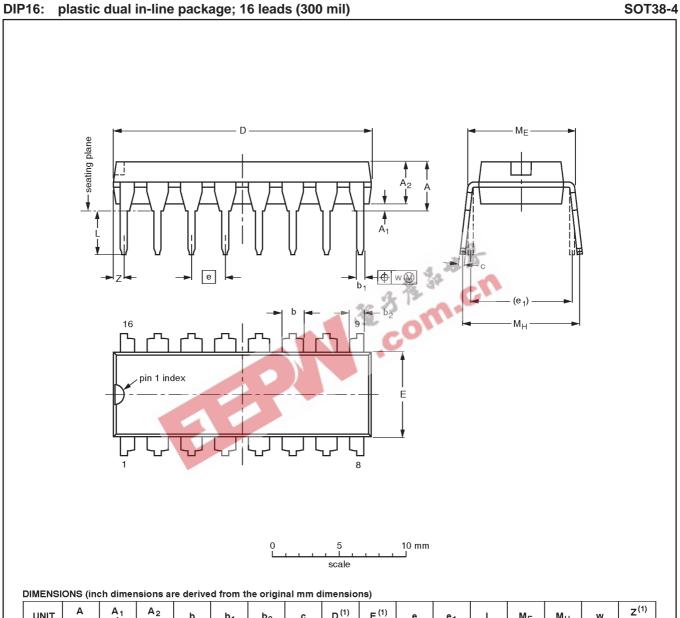


Figure 9.Load circuitry for switching times



DIP16, plastic dual in line package, 16 lands (200 m

UNIT	A max.	A ₁ min.	A ₂ max.	b	b ₁	b ₂	с	D ⁽¹⁾	E ⁽¹⁾	е	e ₁	L	M _E	M _H	w	Z ⁽¹⁾ max.
mm	4.2	0.51	3.2	1.73 1.30	0.53 0.38	1.25 0.85	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	0.76
inches	0.17	0.020	0.13	0.068 0.051	0.021 0.015	0.049 0.033	0.014 0.009	0.77 0.73	0.26 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.030

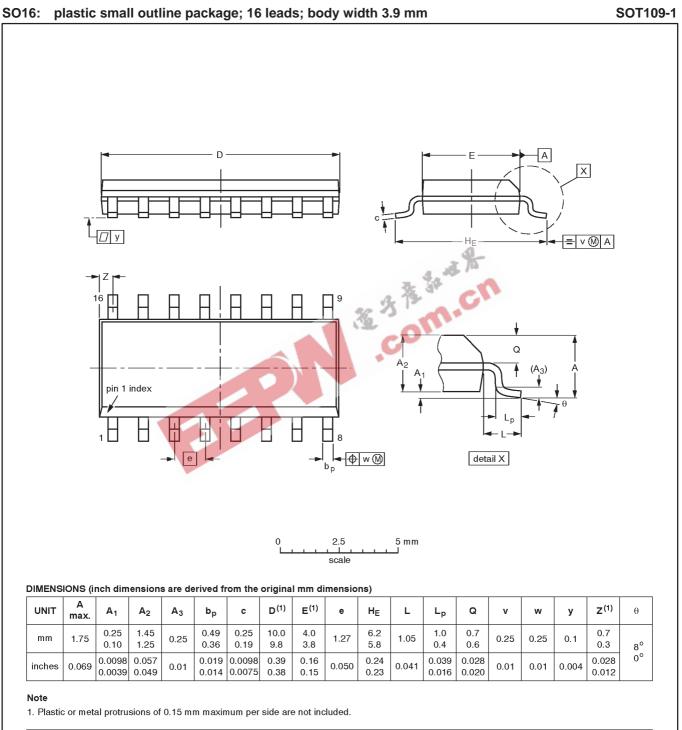
Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFEF	RENCES	EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE	
SOT38-4					-92-11-17 95-01-14	

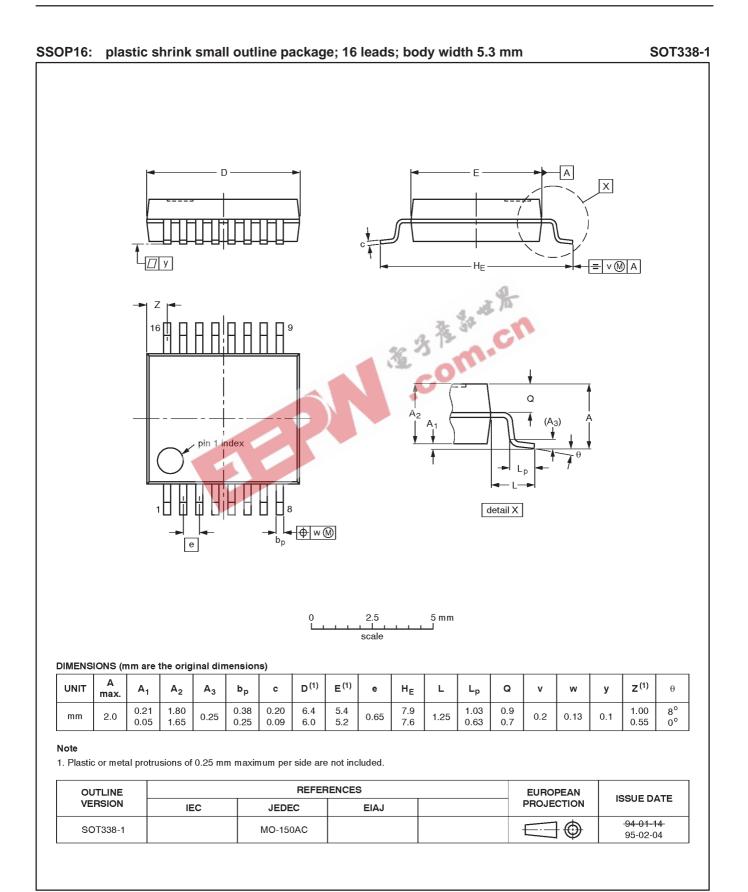
Product specification

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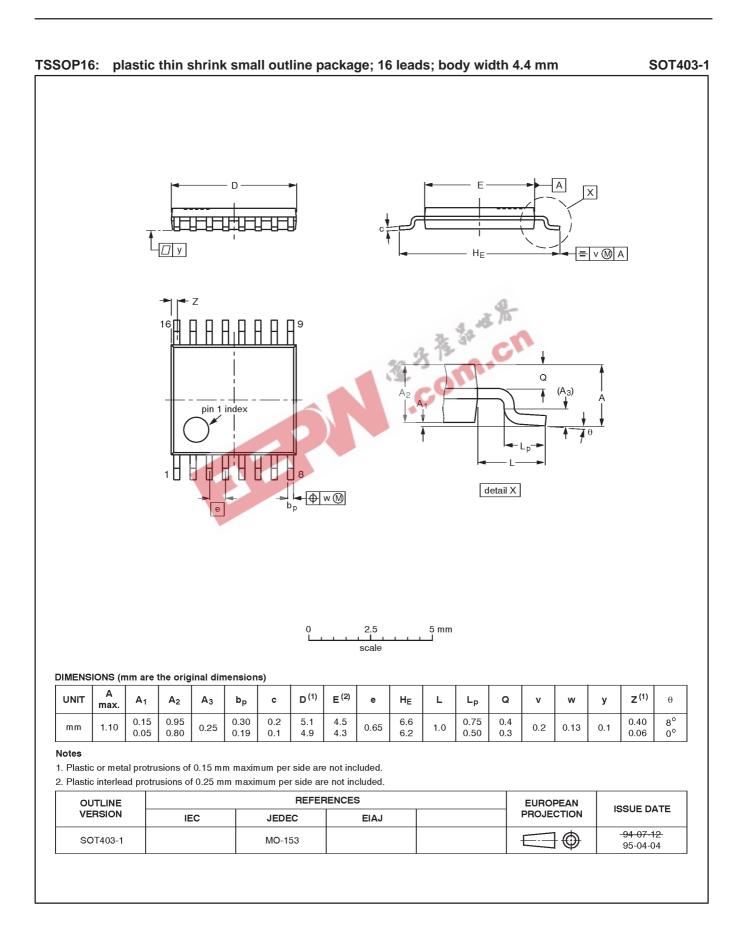


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VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE	
SOT109-1	076E07S	MS-012AC			91-08-13 95-01-23	

74LV4040



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Product specification

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NOTES



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Data sheet status

Data sheet status	Product status	Definition ^[1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
Preliminary specification	Qualification	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make chages at any time without notice in order to improve design and supply the best possible product.
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[1] Please consult the most recently issued datasheet before initiating or completing a design.

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